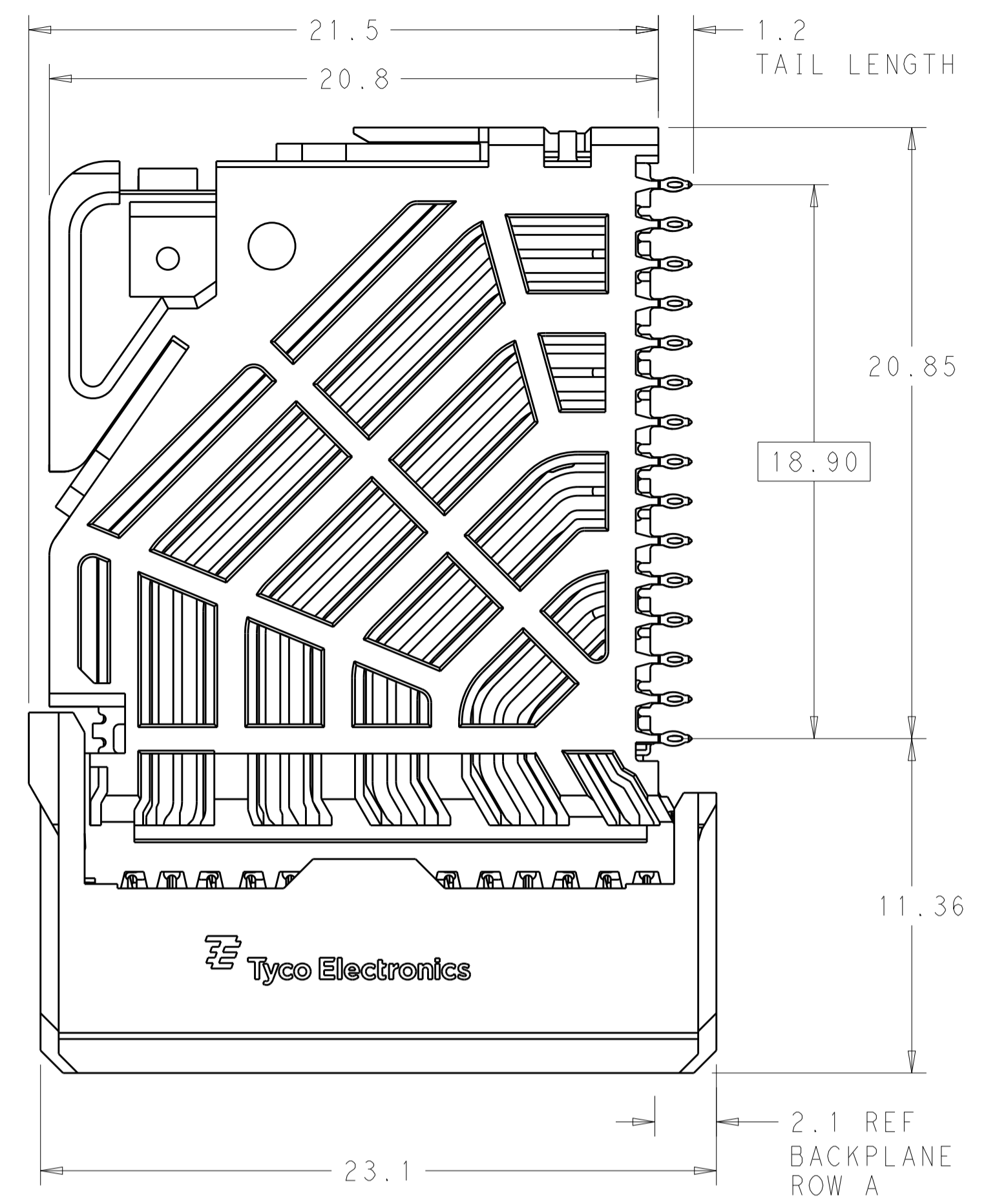
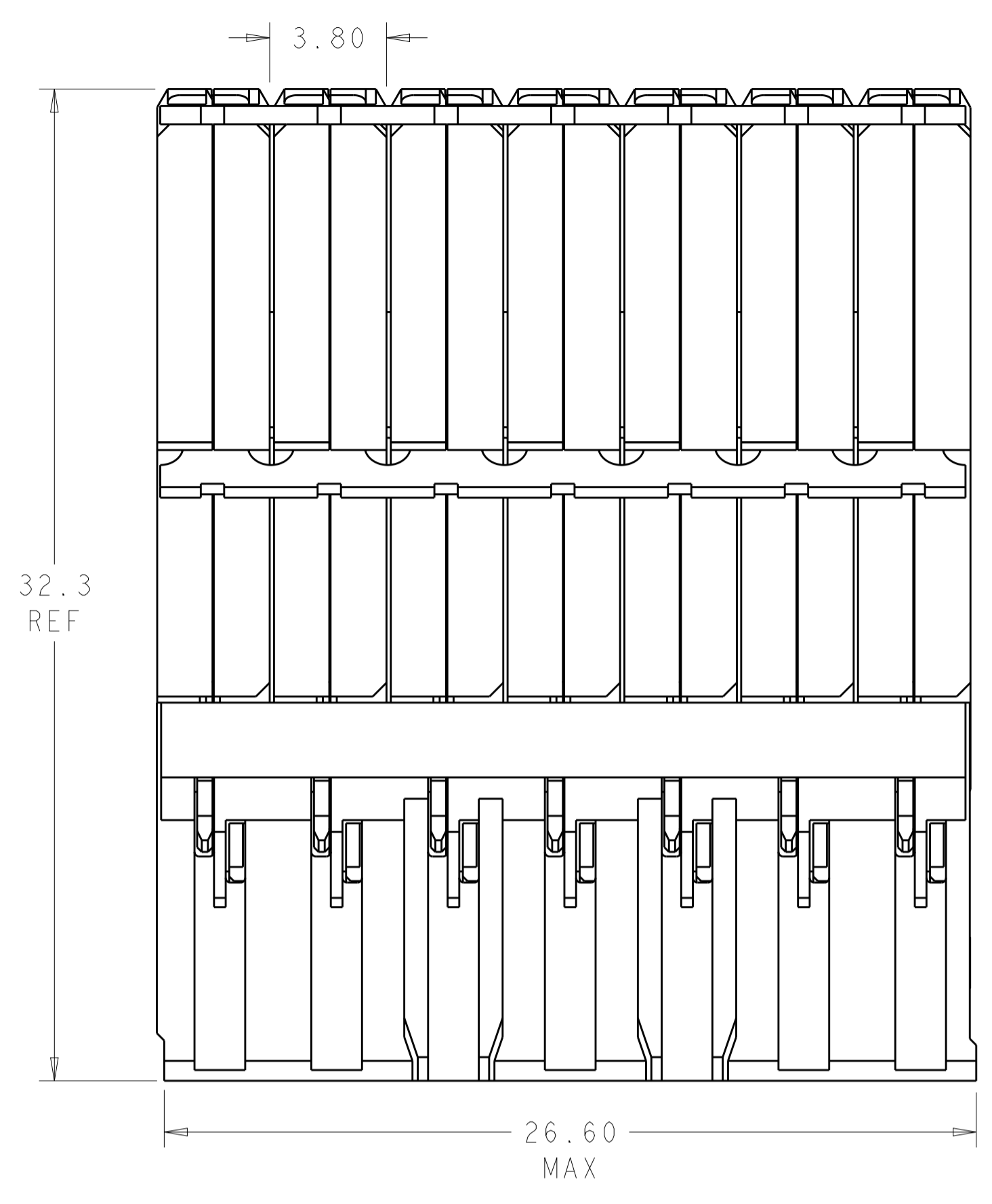
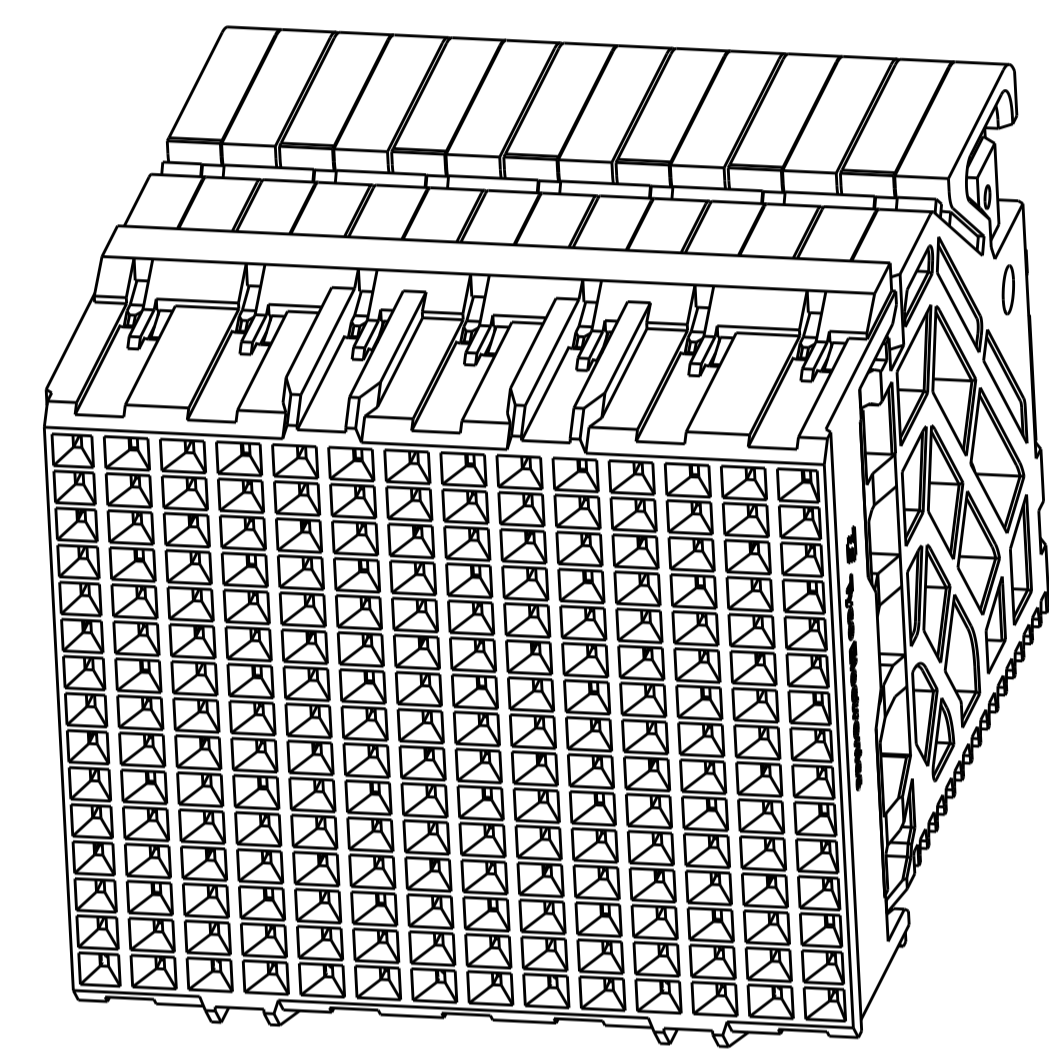


REVISIONS				
P.	LTN	DESCRIPTION	DATE	DWN APVD
C2		REVISED PER ECO-15-004915	10APR2015	AP DD

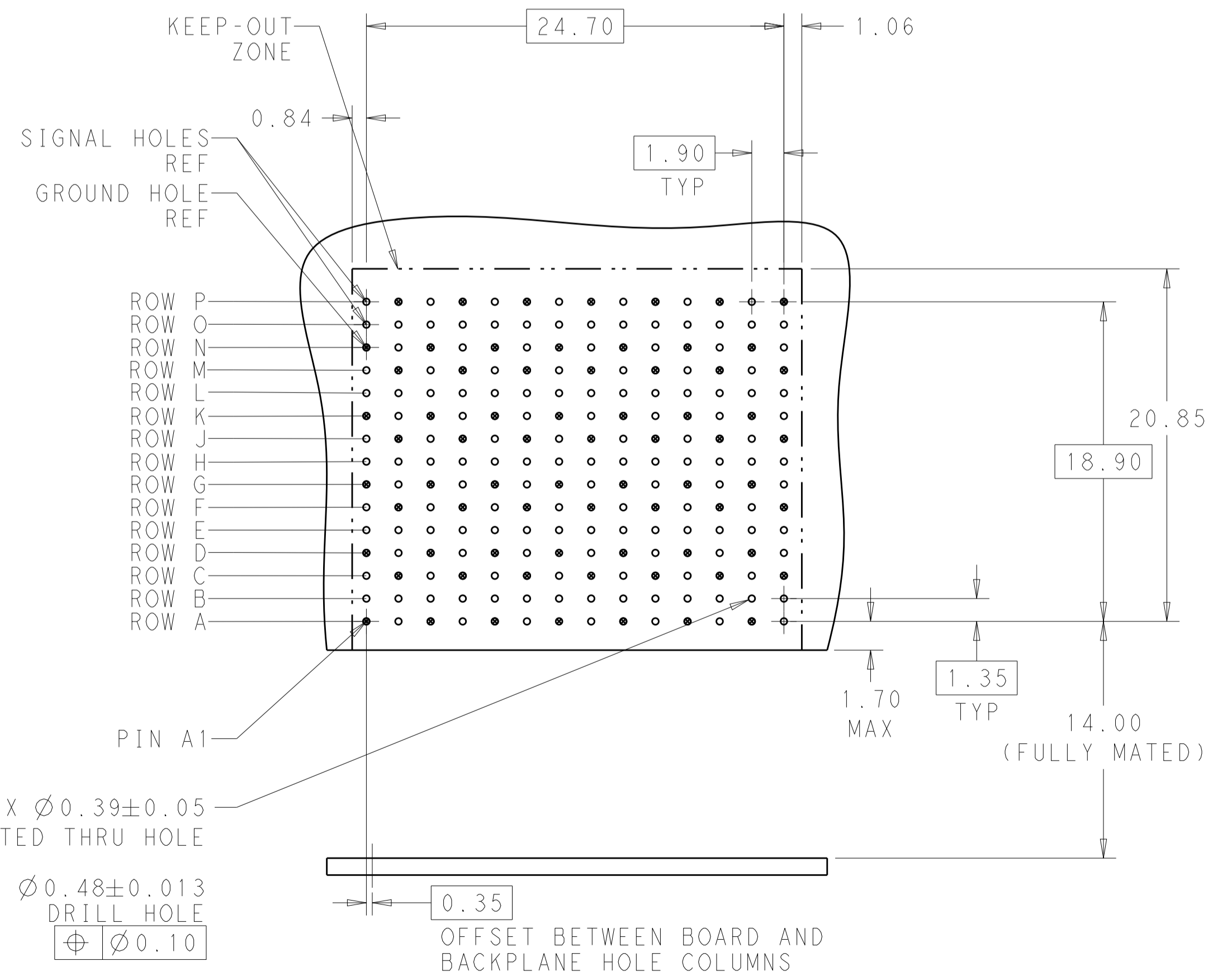
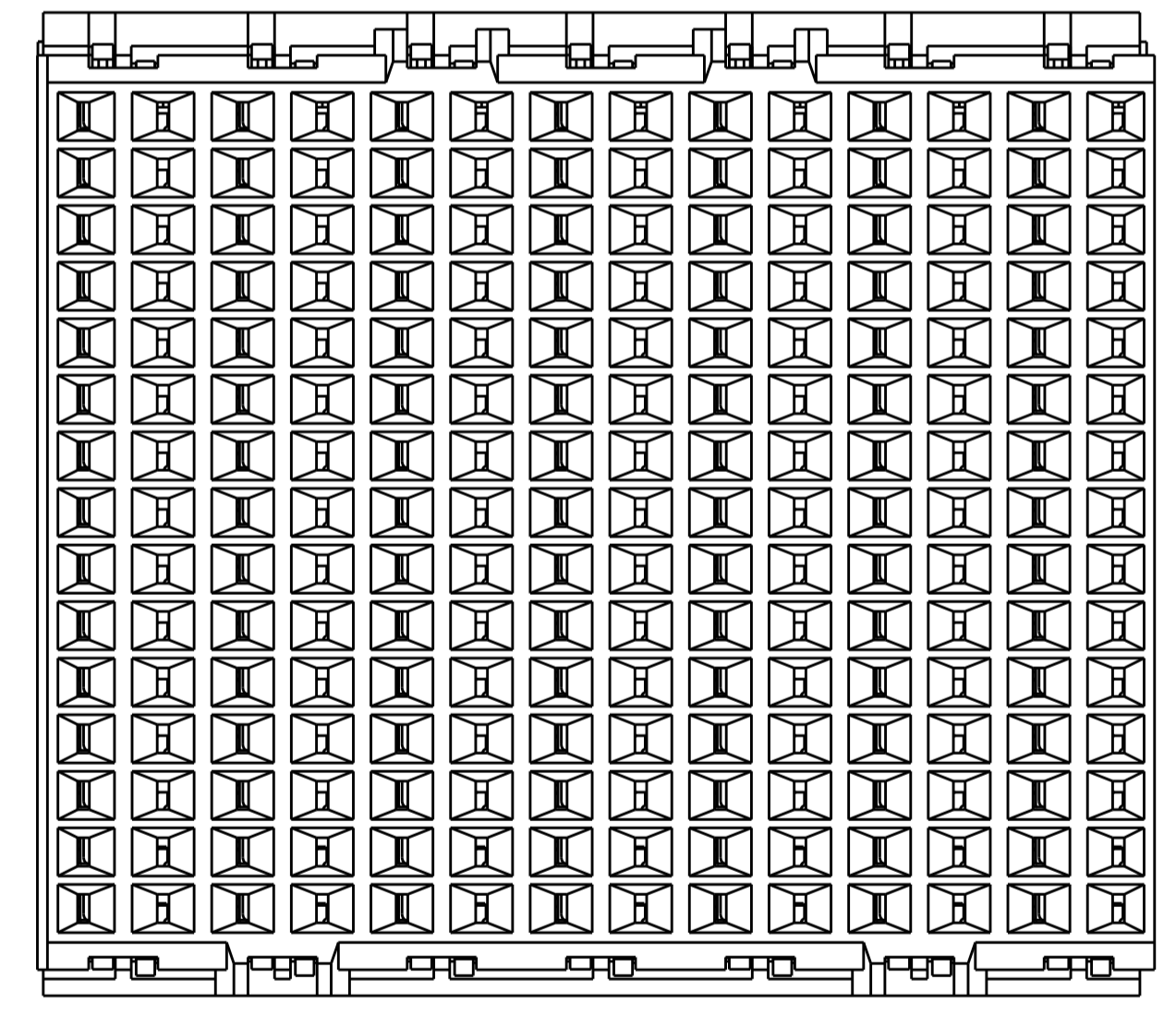


⚠ MATERIAL:
 HOUSING: LCP, GLASS FILLED, UL94V-0.
 TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

⚠ FINISH:
 30μ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.



SCALE 4:1



210X $\varnothing 0.39 \pm 0.05$
 PLATED THRU HOLE

210X $\varnothing 0.48 \pm 0.013$
 DRILL HOLE
 $\varnothing 0.10$

OFFSET BETWEEN BOARD AND
 BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
 MIN BOARD THICKNESS 1.0

REFER TO WWW.TE.COM
 FOR PRODUCT AVAILABILITY

NONE	⚠	2110118-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN Z. MILLER 17SEP2010	TE Connectivity NAME: IMPACT, STD, R/A, 5 PAIR, 14 COLUMN, DAUGHTERCARD, UNGUIDED SIGNAL MODULE, 0.39 EYELET SIZE: CAGE CODE DRAWING NO: A100779C=2110118 RESTRICTED TO:
DIMENSIONS: mm		CHK D. DIXON 17SEP2010	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD D. DIXON 17SEP2010	
0 PLC ± 1 PLC ±0.2 2 PLC ±0.10 3 PLC ± 4 PLC ± ANGLES ±		PRODUCT SPEC	
MATERIAL		SEE TABLE	APPLICATION SPEC
FINISH		SEE TABLE	WEIGHT
Customer Drawing		SCALE 6:1	SHEET 1 OF 1 REV C2